



30V N-Channel Enhancement Mode MOSFET

Voltage

30 V

Current

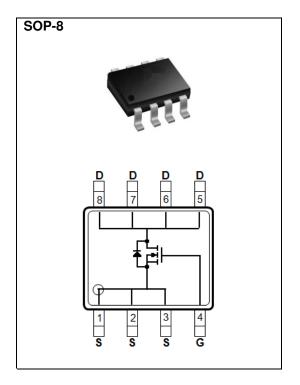
10 A

Features

- R_{DS(ON)}, V_{GS}@10V,I_D@10A<12mΩ
- R_{DS(ON)}, V_{GS}@4.5V,I_D@5A<18mΩ
 High switching speed
- Improved dv/dt capability
- Low Gate Charge
- Low reverse transfer capacitance
- Lead free in compliance with EU RoHS2.0 (2011/65/EU & 2015/865/EU directive)
- Green molding compound as per IEC61249 Std.. (Halogen Free)

Mechanical Data

- Case: SOP-8 package
- Terminals: Solderable per MIL-STD-750, Method 2026
- Approx. Weight: 0.0026 ounces, 0.0742 grams



Maximum Ratings and Thermal Characteristics (T_A=25°C unless otherwise noted)

PARAMETER		SYMBOL	LIMIT	UNITS	
Drain-Source Voltage		V _{DS}	30	V	
Gate-Source Voltage		V_{GS}	<u>+</u> 20	V	
Continuous Drain Current	T _A =25°C		10		
	T _A =70°C	l I _D	8	Α	
Pulsed Drain Current (Note 1)		I _{DM}	40		
Power Dissipation	T _A =25°C	P _D	1.7	W	
	T _A =70°C		1.1		
Operating Junction and Storage Temperature Range		T_{J} , T_{STG}	-55~150	°C	
Typical Thermal Resistance					
- Junction to Ambient, $t \le 10s^{-(Note 6)}$		$R_{\theta JA}$	73.5	°C/W	





Electrical Characteristics (T_A=25 °C unless otherwise noted)

PARAMETER	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNITS		
Static								
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V,I _D =250uA	30	-	-	V		
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}$, $I_{D}=250$ uA	1.2	1.8	2.5			
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} =10V,I _D =10A	-	10	12	mΩ		
Drain-Source On-State Resistance	R _{DS(on)}	V_{GS} =4.5 V , I_D =5 A	-	13	18			
Zero Gate Voltage Drain Current	I _{DSS}	V_{DS} =30V, V_{GS} =0V	-	-	1.0	uA		
Gate-Source Leakage Current	I _{GSS}	V _{GS} = <u>+</u> 20V,V _{DS} =0V	-	-	<u>+</u> 100	nA		
Dynamic (Note 6)								
Total Gate Charge	Q_g	V _{DS} =15V, I _D =5A, V _{GS} =4.5V ^(Note 3)	-	7.1	-	nC		
Gate-Source Charge	Q_gs		-	2.0	-			
Gate-Drain Charge	Q_gd		-	2.8	-			
Input Capacitance	Ciss	V _{DS} =25V, V _{GS} =0V, f=1.0MHZ	_	660	-	pF		
Output Capacitance	Coss		_	92	-			
Reverse Transfer Capacitance	Crss		-	71	-			
Turn-On Delay Time	td _(on)	$V_{DD}{=}15V,\ I_{D}{=}1A,$ $V_{GS}{=}10V,\ R_{G}{=}6\Omega$ (Note 3)	-	6.7	-			
Turn-On Rise Time	tr		_	11	-			
Turn-Off Delay Time	td _(off)		_	27	-			
Turn-Off Fall Time	tf		-	8.3	-			
Drain-Source Diode			_					
Maximum Continuous Drain-Source	l _a		-	-	10	А		
Diode Forward Current	I _S							
Diode Forward Voltage	V_{SD}	I _S =1.0A, V _{GS} =0V	-	0.72	1.0	V		

NOTES:

- 1. Pulse width<a>300us, Duty cycle<2%
- 2. Essentially independent of operating temperature typical characteristics.
- 3. The maximum current rating is package limited.
- 4. Repetitive rating, pulse width limited by junction temperature TJ(MAX)=150°C. Ratings are based on low frequency and duty cycles to keep initial TJ =25°C.
- 5. Reja is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. Mounted on a 1 inch² with 2oz.square pad of copper.
- 6. Guaranteed by design, not subject to production testing.





TYPICAL CHARACTERISTIC CURVES

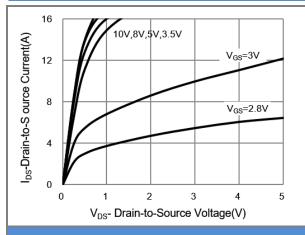


Fig.1 On-Region Characteristics

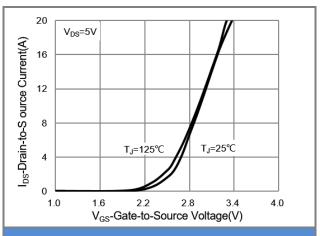


Fig.2 Transfer Characteristics

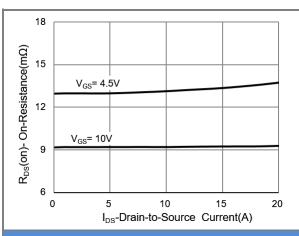


Fig.3 On-Resistance vs. Drain Current

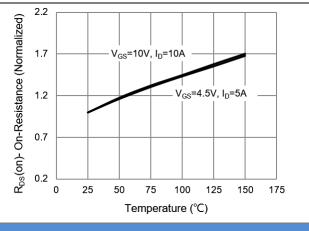


Fig.4 On-Resistance vs. Junction temperature

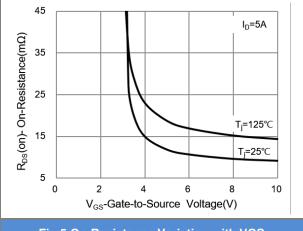


Fig.5 On-Resistance Variation with VGS

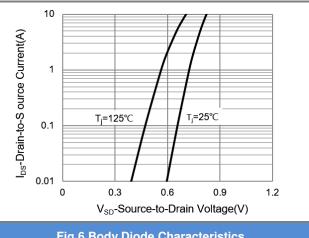


Fig.6 Body Diode Characteristics





TYPICAL CHARACTERISTIC CURVES

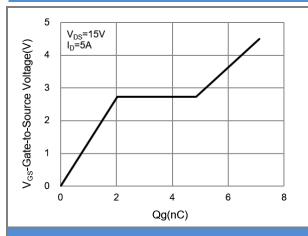


Fig.7 Gate-Charge Characteristics

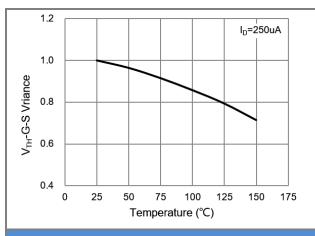


Fig.9 Threshold Voltage Variation with Temperature

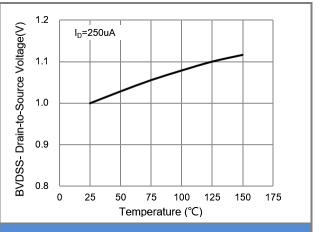


Fig.8 Breakdown Voltage Variation vs. Temperature

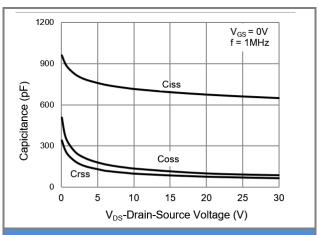


Fig.10 Capacitance vs. Drain-Source Voltage

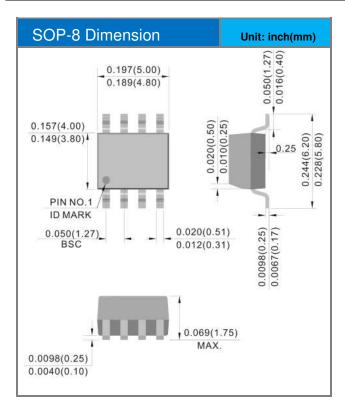


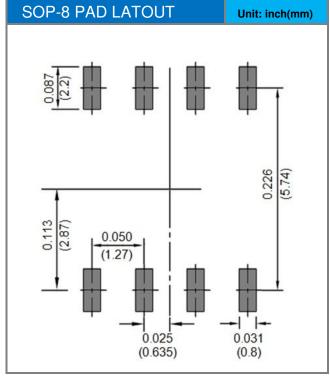


Part No Packing Code Version

Part No Packing Code	Package Type	Packing Type	Marking	Version
PJL9410_R2_00001	SOP-8	2.5K pcs / 13" reel	L9410	Halogen free

Packaging Information & Mounting Pad Layout









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